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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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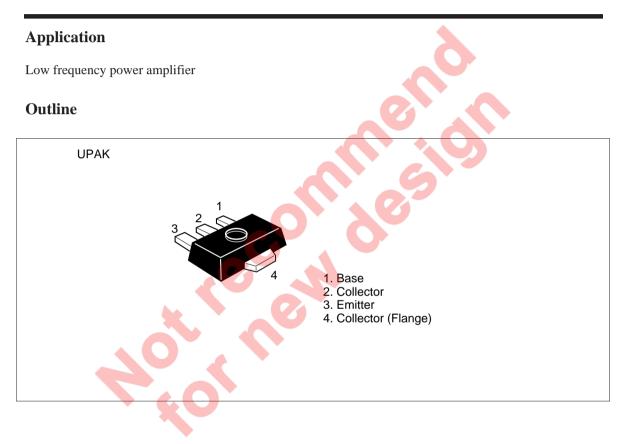
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Silicon NPN Epitaxial

RENESAS

ADE-208-1146 (Z) 1st. Edition Mar. 2001



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

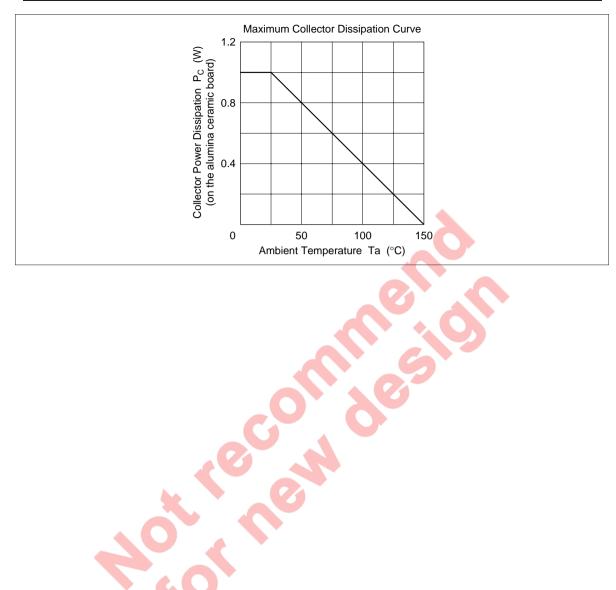
Item	Symbol	Ratings	Unit	
Collector to base voltage	V _{CBO}	30	V	
Collector to emitter voltage	V _{CEO}	25	V	
Emitter to base voltage	V _{EBO}	5	V	
Collector current	I _c	1	А	
Collector peak current	i _{C(peak)} *1	1.5	А	
Collector power dissipation	P _c * ²	1	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	٥°	
 Notes: 1. PW ≤ 10 ms, Duty cycle ≤ 20%. 2. Value on the alumina ceramic board (12.5 × 20 × 0.7 mm) 				
Electrical Characteristics (Ta = 25°C)				

Electrical Characteristics (Ta = 25°C)

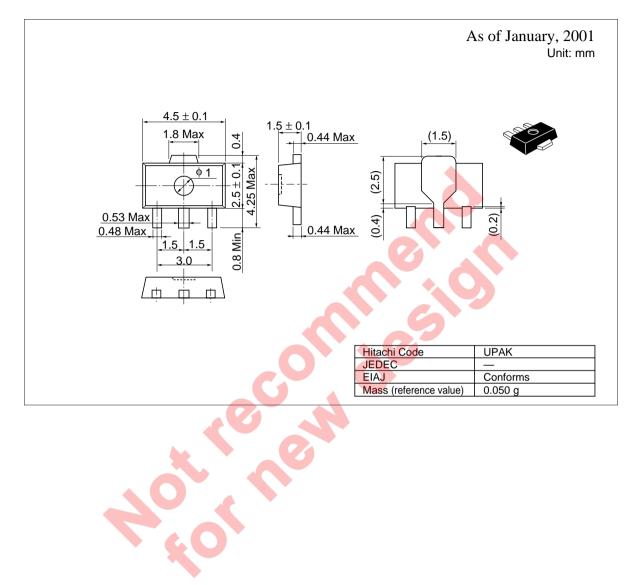
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	30		-	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	V _{(BR)CEO}	25		0	V	$I_c = 1 \text{ mA}, \text{ R}_{BE} = \infty$
Emitter to base breakdown voltage	V _{(BR)EBO}	5	J.		V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	- 6	_	0.1	μA	$V_{CB} = 20 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	A		0.1	μA	$V_{EB} = 4 V, I_{C} = 0$
DC current transfer ratio	h _{FE} *1	85	_	240		V_{ce} = 2 V, I_c = 0.5 A, Pulse
Collector to emitter saturation voltage	V _{CE(sat)}	-	0.15	0.3	V	$I_{c} = 0.8 \text{ A}, I_{B} = 0.08 \text{ A}, \text{Pulse}$
Base to emitter saturation voltage	V _{BE(sat)}	_	0.9	1.0	V	$I_{c} = 0.8 \text{ A}, I_{B} = 0.08 \text{ A}, \text{Pulse}$
Gain bandwidth product	f _T	_	240	_	MHz	V_{ce} = 2 V, I_c = 0.5 A, Pulse
Collector output capacitance	Cob	_	22	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Note: 1. The 2SD1366A is g		h _{FE} as fo	llows.			

marix	NO	AB .
h _{FE}	85 to 170	120 to 240

See characteristic curves of 2SD1366.



Package Dimensions



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Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose, CA 95134 Tel: <1> (408) 433-1990 Germany

Hitachi Europe GmbH Electronic Components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Fax: <1>(408) 433-0223 Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel : <65>-538-6533/538-8577 Fax : <65>-538-6933/538-3877 URL : http://www.hitachi.com.sg

Hitachi Asia Ltd. (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building, Taipei (105), Taiwan Tel: <886>-(2)-2718-3666 Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP URL : http://www.hitachi.com.tw

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong Tel : <852>-(2)-735-9218 Fax : <852>-(2)-730-0281 URL : http://www.hitachi.com.hk

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